

SPECIFICATION

Revision: 0.0

WKS101WX001C-WCT

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

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REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2022-9-16	First release	Preliminary

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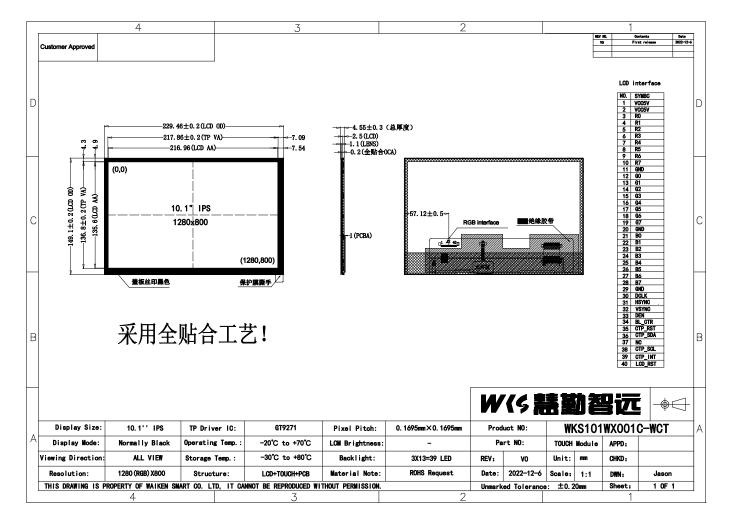


1. GENERAL INFORMATION

Item of general information		Contents	Unit
LCD Display Size (Diagonal)		10.1	inch
Module Structure	LO	CD + C-Touch + PCB	-
LCD Display Type	T	FT/TRANSMISSIVE	-
LCD Display Mode		Normally Black	-
Recommended Viewing Direction		Free	-
Module size (W×H×T)	2	229.46×149.10×4.55	mm
Active area (W×H)	216.96×135.60		mm
Number of pixels (Resolution)	1280(RGB)×800		pixel
Pixel pitch (W×H)		0.1695×0.1695	mm
Color Pixel Arrangement		RGB Stripe	-
Madala Intensa a Tana	LCD	RGB Interface	-
Module Interface Type	TOUCH	I2C interface	-
Module Input voltage	5.0V		V
Module Power consumption	-		mA
Color Numbers	16.7M		-
Backlight Type		White LED	-

2. EXTERNAL DIMENSIONS

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3 ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max 60°C)	RH

Note: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

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Sep 16, 2022

4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit
PCB operating voltage	VCC5V	-	5.0	-	V
LCD operating voltage	VDD	2.3	2.5	3.6	V
Input voltage 'H' level	VIH	0.8*VDD	-	3.6	V
Input voltage 'L' level	VIL	0	-	0.2*VDD	V

5. TOUCH CHARACTERISTICS

Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	1280×800	pixel	-
Surface Hardness	6Н	-	-
Transparency	≥86%	-	-
Driver IC	GT9271	-	-
Interface Type	I2C	-	-
Support Points	10	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

6, ELECTRO-OPTICAL CHARACTERISTICS

Item (electro-op character	otical	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0.0	-	25	50	ms	FIG 1.	4
Contrast F	Ratio	CR	θ=0 Ø=0	-	600	ı	1	FIG 2.	1
Luminance un	iformity	δWHITE	Ta=25°C	_	80	-	%	FIG 2.	3
Surface Lum	ninance	Lv		-	300	-	cd/m2	FIG 2.	2
CIE (x, y)		White x	θ=0	0.27	0.31	0.35			
chromaticity	White	White y	Ø=0 Ta=25°C	0.28	0.32	0.36	1	FIG 2.	5
	Ø=90(1	2 o'clock)		75	85	-	deg		
Viewing	Ø=270(6 o'clock)	$CR \ge 10$	75	85	-	deg	FIG 3.	6
angle range	Ø=0(3 d	o'clock)	CK 2 10	75	85	-	deg	FIG 3.	0
	Ø=180(9 o'clock)		75	85	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

Note 1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P 3,P4, P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance (δWHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of 9 points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.



 $\delta \text{WHITE} = \frac{Minimum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}{Maximum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}$

Note 4. The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For more information see FIG 1.

Note 5. CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

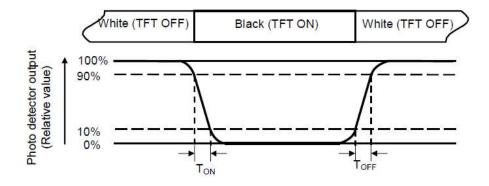


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

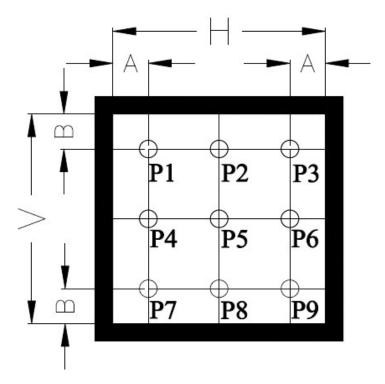
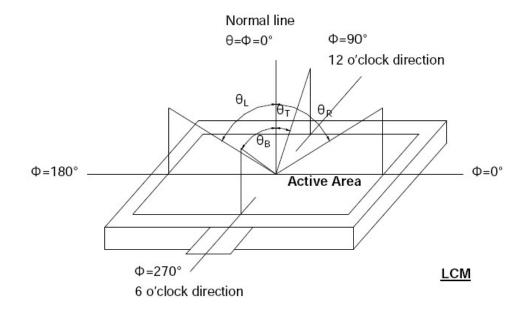


FIG.3. The definition of viewing angle



7. INTERFACE DESCRIPTION

TOUCH MODULE

NO.	Symbol	I/O	DESCRIPTION	
1~2	VCC5V	Р	Module Power supply (5V Typ.)	
3~10	R0~R7	I	8bit digital Red data input(R0:LSB; R7:MSB)	
11	GND	Р	Power ground	
12~19	G0~G7	I	8bit digital Green data input(G0:LSB; G7:MSB)	
20	GND	Р	Power ground	
21~28	B0~B7	I	8bit digital Blue data input(B0:LSB; B7:MSB)	
29	GND	Р	Power ground	
30	DCLK	I	Clock signal.	
31	HSYNC	I	Horizontal Sync input.	
32	VSYNC	I	Vertical Sync input.	
33	DEN	I	Data input Enable.	
34	BL_CTR	I	Backlight control pin	
35	TP_RST	I	CTP external reset signal, Low is active	
36	TP_SDA	I/O	CTP I2C data input and output	
37	NC	-	No connection	
38	TP_SCL	I	CTP I2C clock input	
39	TP_INT	I/O	CTP External interrupt to the host	
40	NC	-	No connection	

Application Note:

For RGB interface input:

1. For RGB565 Input Format: R3~R7, G2~G7, B3~B7 be used.

2、For RGB666 Input Format: R2~R7, G2~G7, B2~B7 be used.

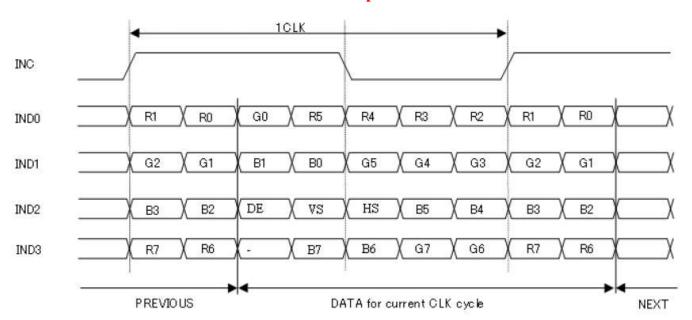


8. INPUT TIMING

RGB Input Timing Table

Parameter	Symbol		Unit		
rarameter	Symbol	Min.	Тур.	Max.	Unit
DCLK frequency@ Frame rate=60Hz	DCLK	66.3	72.4	78.9	MHz
Horizontal display area	thd	1280			DCLK
HSYNC pulse width	thpw	2 - 40		40	DCLK
HSYNC Back Porch(Blanking)	thb	88 88 88		88	DCLK
HSYNC Front Porch	thfp	12 72 132		132	DCLK
Vertical display area	tvd	800			Н
VSYNC pulse width	tvpw	2 - 20		Н	
VSYNC Back Porch(Blanking)	tvb	23	23	23	Н
VSYNC Front Porch	tvfp	1	15	49	Н

LVDS Data Input Format



Version:0.0



9、RELIABILITY TEST CONDITIONS

TOUCH MODULE

No.	Test Item	Test Condition
1	High Temperature Storage	80°C/120 hours
2	Low Temperature Storage	-30°C/120 hours
3	High Temperature Operating	70°C/120 hours
4	Low Temperature Operating	-20°C/120 hours
5	Temperature Cycle Storage	0°C(30min.)~25(5min.)~50°C(30min.)×10cycles

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in the LCD;
- Sealleak;
- Non-display;
- Missing segments;
- Glass crack;
- Current is twice higher than initial value.

B. Remark:

- The test samples should be applied to only one test item.
- Sample size for each test item is 5~10pcs.
- Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



10, INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

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Sample plan 10.1

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

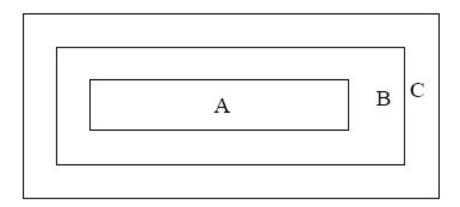
Minor defect: AQL 1.5

10.2 **Inspection condition**

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25°C and normal humidity 60 $\pm 15\%RH$)

Definition of Inspection Item. 10.3

Definition of inspection zone in LCD. A



Zone A: character/Digit area



Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

B, Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under
	black pattern.
Doub dot	Dots appear dark and unchanged in size in which LCD panel is displaying
Dark dot	under pure red, green, blue picture, or pure whiter picture.

10.4 Major Defect

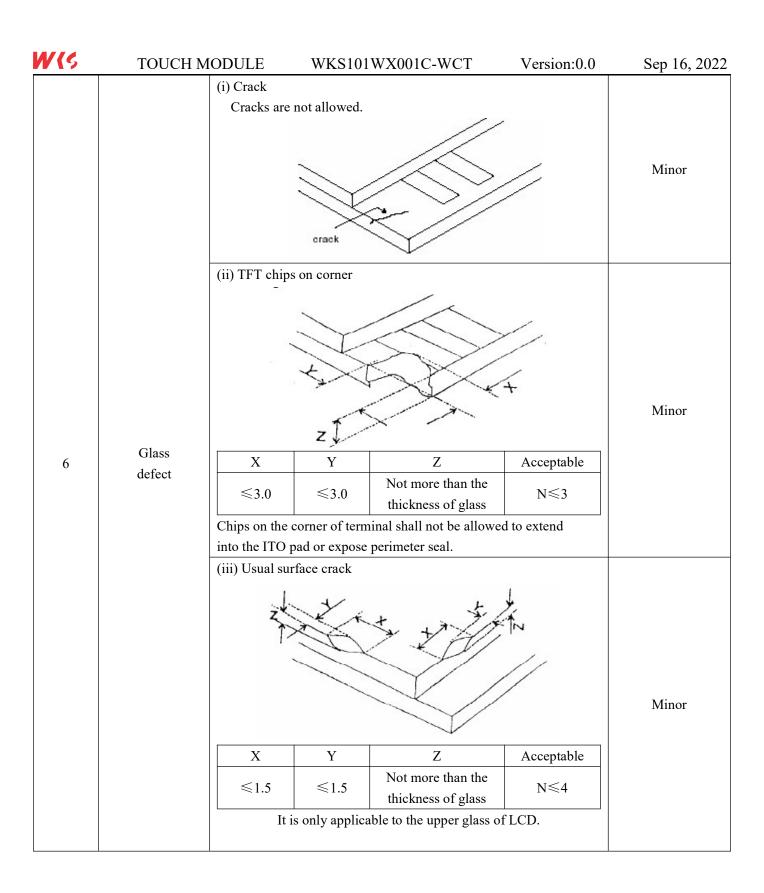
Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	



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Item No.	Items to be inspected	Inspection standard						Classification of defects	
	Bright dot /dark dot defect		Acceptable Qty A+B						
					4.3"~		>10.1"	С	
		Bright pixel dot		t	1	2	3		
		Dark pixel dot			4	4	4	Ac	
1		2bright dots adjac		cent	0	0	0	Acceptable	Minor
		2dark dots adjac		eent	0	0	0	able	
		Total bri	ight and da	rk dots	5	6	7		
		Note: Minimum distance between defective dots is more than 5mm;							
		Pixel dots' function is normal, but bright dots caused by foreign							
		material a							
	Dot defect		Acceptable Qty						
					A+B				
		Size(mm) $\Phi \leq 0.2$				>10.1"	С		
2				Acceptable Acce		Acceptable	ceptable Acceptable	Ac	
		0.2<Φ≤0.5		4		5	6	Acceptable	Minor
		Ф>0.5		0		0	0	ble	
		Note: 1. Minimum distance between defective dots is more than 5 mm; 2. The quantity of defect is zero in operating condition.							
3	Linear defect		Zone Acceptable Qty						
		Size (mm)		A+B					
		Length	Width	4.3"~	7"	7∼10.1"	>10.1"	С	
		Ignore	W≤0.05	Accept	able .	Acceptable	Acceptable	Ac	Minor
		L≤5.0	0.05 < W≤0.1	4		5	6	Acceptable	
		L>5.0	W>0.1	0		0	0		

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4	Polarizer defect	(i) Shiftir dimension (ii) Incorallowed. 5.4.2 Dirt Dirt which 5.4.3 Pola Size(mm 0.2<0 5.4.4 Pol. (i) If the jor in the (ii) If the	on polarizer on can be we rizer Dent Zone 0.2 0.2 0.5 > 0.5 arizer scrapolarizer soperating or polarizer or some Zone	on should not ering of the vier iped easily shows Air bubble 4.3"~7" Acceptable 4	Acceptable A+B 7~10.1" Acceptable 5 0 e seen after cadge by the libe seen only	able. Qty >10.1" Acceptable 6 0 cover assembnear defect of in non-operate following:	C Acceptable ling of 5.3.	Minor
5	MURA	Using :						
	White/Black dot (MURA)	Vi 0.15	Minor					





10.6 Module Cosmetic Criteria

Item	Items to be	Inspection Standard	Classification
No.	inspected	-	of defects
1	Difference in Spec.	Not allowable	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
		No soldering missing	Major
3	Soldering defects	No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on PCB	Visible copper foil (Φ 0.5 mm or more) on substrate	Minor
-	Resist naw on 1 CD	pattern is not allowed	
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed Φ0.2mm)	Minor
9	Stain	No stain to spoil cosmetic badly	Minor
10	Plate discoloring	No plate fading, rusting and discoloring	Minor
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor
	1. Dead parts	b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
	Either 'Toe'(A) or 'Seal'(B)of the lead to be of "Filet". Lead form to be assume over Solder.		Minor
11	3. Chips	(3/2) H ≥h ≥(1/2) H \$\int_h \hat{\hat{h}}\$ H	Minor
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h \geq 0.13 mm. The diameter of solder ball d \leq 0.15 mm.	Minor
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major